

# Epoxy Resin 5230AB

## I. Statement of purpose

Epoxy resin **5230AB** is epoxy resin white potting adhesive cured at room temperature and low temperature, with good fluidity, good surface gloss and heat curing. It is specially used for electronic potting, LED module potting, mold potting and other electronic parts insulation, moisture-proof potting, confidentiality masking, etc.

## II. Pre-sclerotic properties.

	<b>A glue 5230A</b>	<b>curing agent 5230B</b>
Color:	white	colorless and transparent
weight:	1.65	0.96
Viscosity 25℃:	<u><b>25000-50000CPS</b></u>	<u><b>250MAXCPS</b></u>

## III. Conditions of use

1)mixing ratio:	<u><b>A: B=100: 20 (weight ratio)</b></u>
2)hardening condition:	<u><b>25℃×8H-10H or 55℃×2H(2g)</b></u>
3)usable time:	<u><b>25℃×50min (100g)</b></u>

## IV. Methods of use.

1. Working environment: keep the glue container clean, A, B components strictly according to the weight ratio, accurate weighing, clockwise along the inner wall of the container to mix well and stand for 3-5 minutes after use.
2. Depending on the operating time and dosage of the glue, to avoid waste. When the temperature is lower than 15 ℃, please preheat the A glue to 30 ℃ before glue mixing, easy to operate (low temperature A glue will become thicker); after use must be sealed barrel lid, to avoid moisture absorption caused by the product scrap.
3. When the relative humidity is greater than 85%, the surface of the cured material is easy to absorb water in the air, forming a layer of white mist, so when the relative humidity is greater than 85%, it is not suitable for room temperature curing, it is recommended to use the heating curing.

## V. Properties after hardening

1)hardness:	<b>shore D</b>	<u><b>&lt;80</b></u>
2)withstand voltage:	<b>KV/mm</b>	<b>22</b>
3)bending strength:	<b>Kg/mm2</b>	<b>22</b>
4)volume resistance:	<b>Ohm3</b>	<b>1x10*15</b>
5)surface resistance:	<b>Ohmm2</b>	<b>5X10*15</b>
6) thermal conductivity:	<b>W/M.K</b>	<b>0.60</b>
7) electrostatic losses:	<b>1KHZ</b>	<b>0.42</b>
8) heat distortion temperature:	<b>℃</b>	<b>140</b>
9) water absorption:	<b>%</b>	<b>&lt;0.15</b>
10)compressive strength:	<b>Kg/mm2</b>	<b>12.0</b>

The above performance data are typical data measured in a laboratory environment

**with a temperature of 25℃ and a humidity of 70%, and are for customers' reference only.**